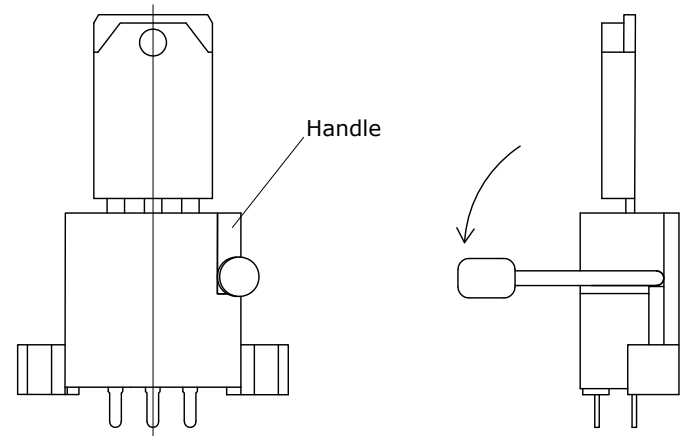
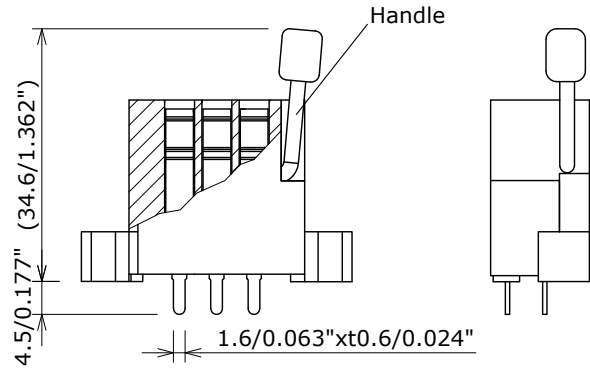
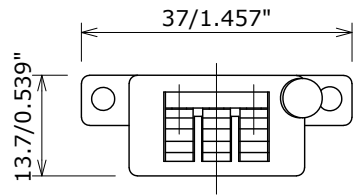
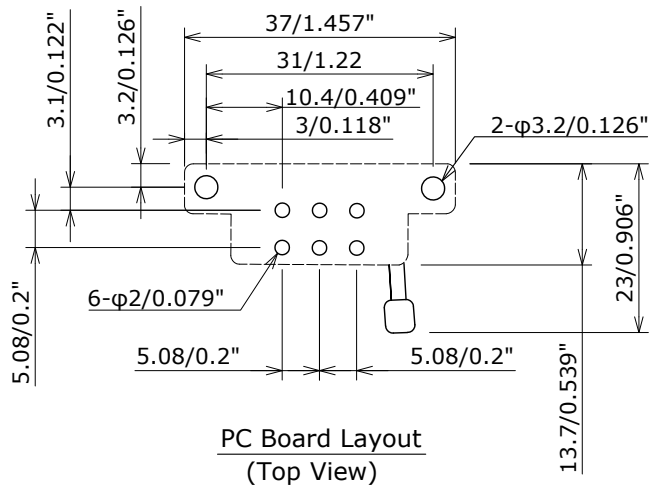
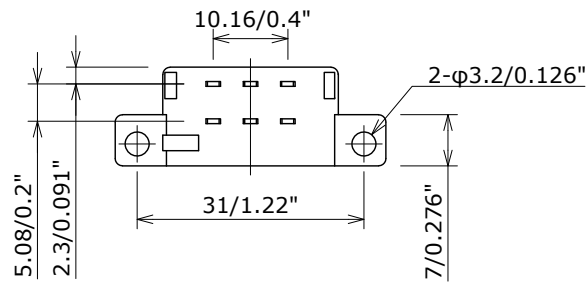
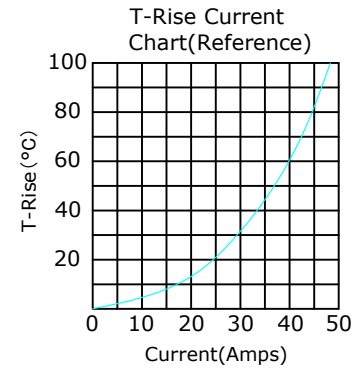


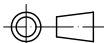


Device Set



PC Board Layout
(Top View)



Date		JC ELECTRONICS CORPORATION	
2025/04/16			
Materials Finish		BODY CONTACT	High Temp. Thermoplastic Copper Alloy, Au plating over Ni
Dimensions Style mm / inch		Title	Power Transistor Test Sockets
 Third Angle Projection		Part Number	
Rev.No		T3P-H248-ZIF	
0			